

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("5324535").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 16:14
L4	101	((pretreat\$3 or scrubb\$3) same laminat\$3) same (circuit near board or "PCB")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 17:37
L5	1	4 same (solder\$3 near resist)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 17:42
L6	3	4 and (solder\$3 near resist)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 17:41
L7	91	4 and @pd<"20030603"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 17:42
L8	39	7 and ((thermosett\$3 near resin) or (epoxy near resin))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/17 17:43
S1	1174	(thermosetting near resin) same (printed near circuit near board or "PCB" or "MLB" or "PWB")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:15
S2	39	S1 same laser	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:39
S3	12	S2 and (solder\$3 near resist)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:27

S4	16	S2 and (clean\$3 or wash\$3 or scrubb\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:31
S5	3	mok-jee-soo.in.	US-PGPUB; USPAT	OR	OFF	2005/05/16 20:35
S6	10	kang-jang-kyu.in.	US-PGPUB; USPAT	OR	OFF	2005/05/16 20:35
S7	5	S6 and (solder\$3 near resist)	US-PGPUB; USPAT	OR	OFF	2005/05/16 20:37
S8	1	nam-chang-hyun.in. and (solder\$3 near resist)	US-PGPUB; USPAT	OR	OFF	2005/05/16 20:38
S9	3	nam-chang-hyun.in.	US-PGPUB; USPAT	OR	OFF	2005/05/16 20:38
S10	0	S1 same scrubb\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:39
S11	11	S1 and scrubb\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/05/16 20:39